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ON Semiconductor NSS40601CF8T1G

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NSS40601CF8T1G

40 V, 8.0 A, Low V_{CE(sat)} **NPN Transistor**

ON Semiconductor's e²PowerEdge family of low V_{CE(sat)} transistors are miniature surface mount devices featuring ultra low saturation voltage (V_{CE(sat)}) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical applications are DC-DC converters and power management in portable and battery powered products such as cellular and cordless phones, PDAs, computers, printers, digital cameras and MP3 players. Other applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

• This is a Pb-Free Device

MAXIMUM RATINGS (T_A = 25°C)

| Rating | Symbol | Max | Unit |
|--------------------------------|------------------|----------------------------|------|
| Collector-Emitter Voltage | V _{CEO} | 40 | Vdc |
| Collector-Base Voltage | V _{CBO} | 40 | Vdc |
| Emitter-Base Voltage | V _{EBO} | 6.0 | Vdc |
| Collector Current - Continuous | I _C | 6.0 | Adc |
| Collector Current - Peak | I _{CM} | 8.0 | Α |
| Electrostatic Discharge | ESD | HBM Class 3B MM Class C | |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|--|-----------------------------------|----------------|-------------|
| Total Device Dissipation, T _A = 25°C Derate above 25°C | P _D (Note 1) | 830 6.7 | mW mW/°C |
| Thermal Resistance, Junction-to-Ambient | R _{θJA} (Note 1) | 150 | °C/W |
| Total Device Dissipation, T _A = 25°C Derate above 25°C | P _D (Note 2) | 1.4 11.1 | W mW/°C |
| Thermal Resistance, Junction-to-Ambient | R _{θJA} (Note 2) | 90 | °C/W |
| Thermal Resistance, Junction-to-Lead #1 | R _{θJL} (Note 2) | 15 | °C/W |
| Junction and Storage Temperature Range | T _J , T _{stg} | -55 to +150 | °C |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

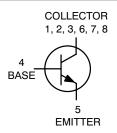
- FR-4 @ 100 mm², 1 oz copper traces.
 FR-4 @ 500 mm², 1 oz copper traces.



ON Semiconductor®

http://onsemi.com

40 VOLTS, 8.0 AMPS NPN LOW $V_{CE(sat)}$ TRANSISTOR EQUIVALENT $R_{DS(on)}$ 31 m Ω





ChipFET™ **CASE 1206A** STYLE 4

MARKING DIAGRAM

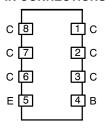


VB = Specific Device Code

M = Month Code

= Pb-Free Package

PIN CONNECTIONS



ORDERING INFORMATION

| Device | Package | Shipping [†] |
|----------------|----------------------|-----------------------|
| NSS40601CF8T1G | ChipFET (Pb-Free) | 3000/ Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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NSS40601CF8T1G

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

| Characteristic | Symbol | Min | Typical | Max | Unit |
|---|-----------------------|--|--|--|------|
| OFF CHARACTERISTICS | | | • | | • |
| Collector-Emitter Breakdown Voltage $(I_C = 10 \text{ mAdc}, I_B = 0)$ | V _{(BR)CEO} | 40 | - | - | Vdc |
| Collector-Base Breakdown Voltage (I _C = 0.1 mAdc, I _E = 0) | V _(BR) CBO | 40 | - | - | Vdc |
| Emitter-Base Breakdown Voltage $(I_E = 0.1 \text{ mAdc}, I_C = 0)$ | V _{(BR)EBO} | 6.0 | - | - | Vdc |
| Collector Cutoff Current (V _{CB} = 40 Vdc, I _E = 0) | Ісво | - | - | 0.1 | μAdc |
| Emitter Cutoff Current (V _{EB} = 6.0 Vdc) | I _{EBO} | - | - | 0.1 | μAdc |
| ON CHARACTERISTICS | <u> </u> | | | | |
| DC Current Gain (Note 3) $ \begin{aligned} &(I_C = 10 \text{ mA}, \ V_{CE} = 2.0 \text{ V}) \\ &(I_C = 500 \text{ mA}, \ V_{CE} = 2.0 \text{ V}) \\ &(I_C = 500 \text{ mA}, \ V_{CE} = 2.0 \text{ V}) \\ &(I_C = 1.0 \text{ A}, \ V_{CE} = 2.0 \text{ V}) \\ &(I_C = 2.0 \text{ A}, \ V_{CE} = 2.0 \text{ V}) \\ &(I_C = 3.0 \text{ A}, \ V_{CE} = 2.0 \text{ V}) \end{aligned} $ | h _{FE} | 200 200 200 200 200 200 | - 395 - - | - - - - | |
| Collector-Emitter Saturation Voltage (Note 3) ($I_C = 0.1 \text{ A}$, $I_B = 0.010 \text{ A}$) ($I_C = 1.0 \text{ A}$, $I_B = 0.100 \text{ A}$) ($I_C = 1.0 \text{ A}$, $I_B = 0.010 \text{ A}$) ($I_C = 1.0 \text{ A}$, $I_B = 0.020 \text{ A}$) ($I_C = 2.0 \text{ A}$, $I_B = 0.020 \text{ A}$) ($I_C = 3.0 \text{ A}$, $I_B = 0.030 \text{ A}$) ($I_C = 4.0 \text{ A}$, $I_B = 0.400 \text{ A}$) | V _{CE(sat)} | - - - - - | 0.008 0.031 0.060 0.075 0.100 0.090 | 0.010 0.075 0.075 0.110 0.150 0.135 | V |
| Base-Emitter Saturation Voltage (Note 3) (I _C = 1.0 A, I _B = 0.01 A) | V _{BE(sat)} | - | 0.760 | 0.900 | V |
| Base-Emitter Turn-on Voltage (Note 3) (I _C = 2.0 A, V _{CE} = 2.0 V) | V _{BE(on)} | - | 0.720 | 0.900 | V |
| Cutoff Frequency (I _C = 100 mA, V _{CE} = 5.0 V, f = 100 MHz) | f _T | 140 | - | - | MHz |
| Input Capacitance (V _{EB} = 0.5 V, f = 1.0 MHz) | Cibo | - | - | 1200 | pF |
| Output Capacitance (V _{CB} = 3.0 V, f = 1.0 MHz) | Cobo | - | - | 100 | pF |
| SWITCHING CHARACTERISTICS | | | | | |
| Delay (V _{CC} = 30 V, I _C = 750 mA, I _{B1} = 15 mA) | t _d | - | - | 110 | ns |
| Rise (V _{CC} = 30 V, I _C = 750 mA, I _{B1} = 15 mA) | t _r | - | - | 130 | ns |
| Storage (V _{CC} = 30 V, I _C = 750 mA, I _{B1} = 15 mA) | t _s | - | - | 1400 | ns |
| Fall (V _{CC} = 30 V, I _C = 750 mA, I _{B1} = 15 mA) | t _f | - | - | 130 | ns |

^{3.} Pulsed Condition: Pulse Width = 300 μsec , Duty Cycle \leq 2%.

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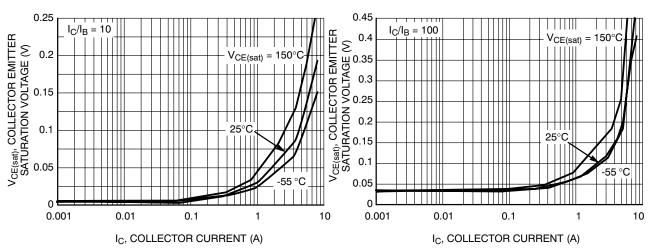


Figure 1. Collector Emitter Saturation Voltage vs. Collector Current

Figure 2. Collector Emitter Saturation Voltage vs. Collector Current

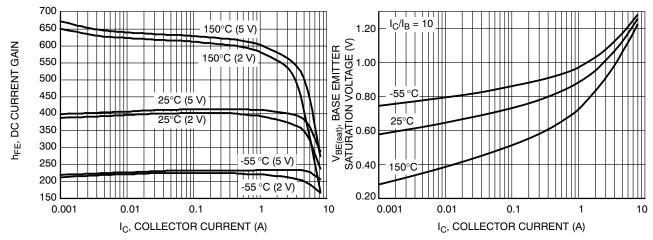


Figure 3. DC Current Gain vs. Collector Current

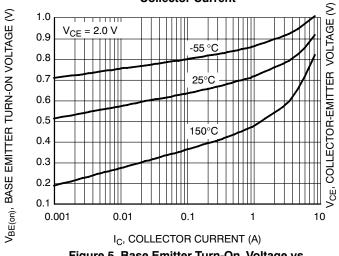


Figure 5. Base Emitter Turn-On Voltage vs. Collector Current

Figure 4. Base Emitter Saturation Voltage vs.
Collector Current

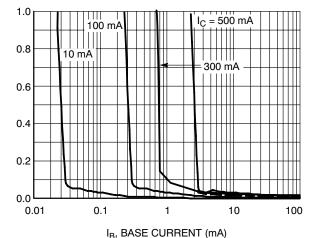
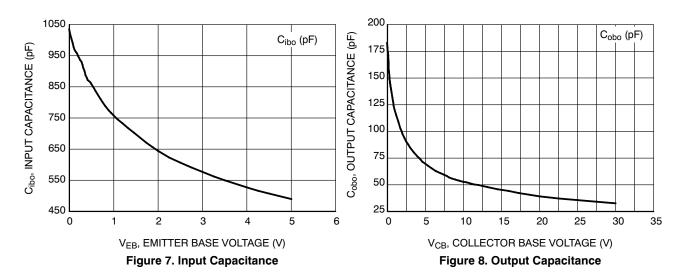


Figure 6. Saturation Region

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10 1.0 5 100 mS 10 mS 1.0 Ic (A) Thermal Limit 0.1 Single Pulse Test at T_{amb} = 25°C 0.01 0.1 1.0 10 100 V_{CE} (V_{dc})

Figure 9. Safe Operating Area

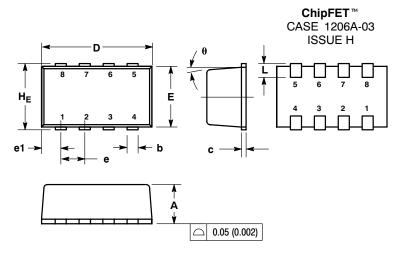
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PACKAGE DIMENSIONS



- ITES:
 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 MOLD GATE BURRS SHALL NOT EXCEED 0.13 MM PER SIDE.
 LEADFRAME TO MOLDED BODY OFFSET IN HORIZONTAL
- AND VERTICAL SHALL NOT EXCEED 0.08 MM.

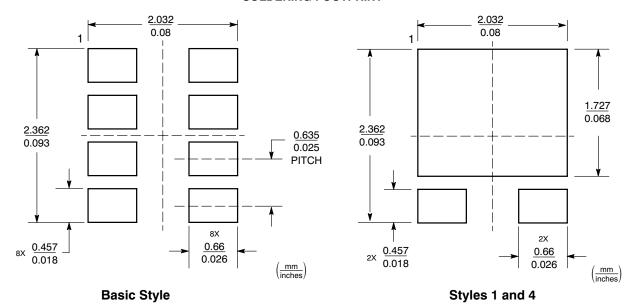
| | | ENSIONS A AND B EXCLUSIV | |
|----|--------|--------------------------|-------------------------|
| 6. | . NO I | MOLD FLASH ALLOWED ON T | THE TOP AND BOTTOM LEAD |
| | SUR | FACE. | |
| г | | | |

| | MILLIMETERS | | | INCHES | | | |
|-----|-------------|------|------|--------|-----------|-------|--|
| DIM | MIN | NOM | MAX | MIN | MOM | MAX | |
| Α | 1.00 | 1.05 | 1.10 | 0.039 | 0.041 | 0.043 | |
| b | 0.25 | 0.30 | 0.35 | 0.010 | 0.012 | 0.014 | |
| С | 0.10 | 0.15 | 0.20 | 0.004 | 0.006 | 0.008 | |
| D | 2.95 | 3.05 | 3.10 | 0.116 | 0.120 | 0.122 | |
| E | 1.55 | 1.65 | 1.70 | 0.061 | 0.065 | 0.067 | |
| е | 0.65 BSC | | | | 0.025 BSC | | |
| e1 | 0.55 BSC | | | | 0.022 BSC | | |
| L | 0.28 | 0.35 | 0.42 | 0.011 | 0.014 | 0.017 | |
| HE | 1.80 | 1.90 | 2.00 | 0.071 | 0.075 | 0.079 | |
| θ | 5° NOM | | | 5° NOM | | | |

- STYLE 4:
 PIN 1. COLLECTOR
 2. COLLECTOR
 3. COLLECTOR
 4. BASE
 5. EMITTER
 6. COLLECTOR
 7. COLLECTOR

 - 8. COLLECTOR

SOLDERING FOOTPRINT*



^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



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